

## 6A High-Speed MOSFET Drivers

### Features

- Latch-Up Protected: Will Withstand >1.5A Reverse Output Current
- Logic Input Will Withstand Negative Swing Up To 5V
- ESD Protected: 4 kV
- Matched Rise and Fall Times:
  - 25 ns (2500 pF load)
- High Peak Output Current: 6A
- Wide Input Supply Voltage Operating Range:
  - 4.5V to 18V
- High Capacitive Load Drive Capability: 10,000 pF
- Short Delay Time: 55 ns (typ.)
- CMOS/TTL Compatible Input
- Low Supply Current With Logic '1' Input:
  - 450  $\mu$ A (typ.)
- Low Output Impedance: 2.5 $\Omega$
- Output Voltage Swing to Within 25 mV of Ground or  $V_{DD}$
- Space-Saving 8-Pin SOIC and 8-Pin 6x5 DFN Packages

### General Description

The TC4420/TC4429 are 6A (peak), single-output MOSFET drivers. The TC4429 is an inverting driver (pin-compatible with the TC429), while the TC4420 is a non-inverting driver. These drivers are fabricated in CMOS for lower power and more efficient operation versus bipolar drivers.

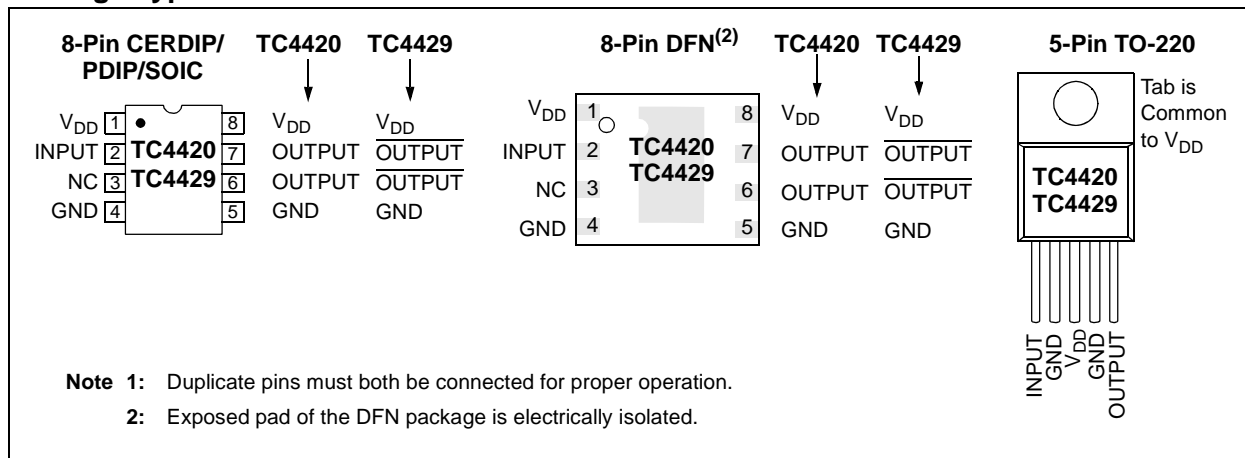
Both devices have TTL/CMOS compatible inputs that can be driven as high as  $V_{DD} + 0.3V$  or as low as  $-5V$  without upset or damage to the device. This eliminates the need for external level-shifting circuitry and its associated cost and size. The output swing is rail-to-rail, ensuring better drive voltage margin, especially during power-up/power-down sequencing. Propagational delay time is only 55 ns (typ.) and the output rise and fall times are only 25 ns (typ.) into 2500 pF across the usable power supply range.

Unlike other drivers, the TC4420/TC4429 are virtually latch-up proof. They replace three or more discrete components, saving PCB area, parts and improving overall system reliability.

### Applications

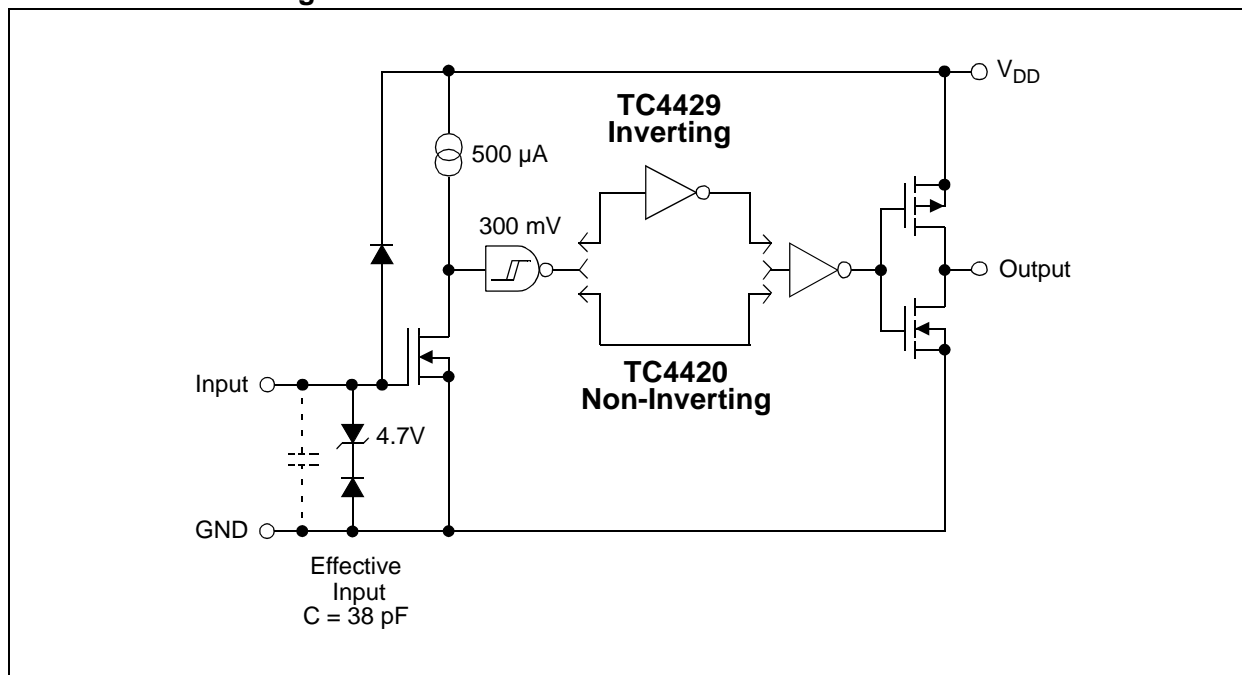
- Switch-Mode Power Supplies
- Motor Controls
- Pulse Transformer Driver
- Class D Switching Amplifiers

### Package Types<sup>(1)</sup>



# TC4420/TC4429

## Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings†

|                                                     |                         |
|-----------------------------------------------------|-------------------------|
| Supply Voltage .....                                | +20V                    |
| Input Voltage .....                                 | - 5V to $V_{DD} + 0.3V$ |
| Input Current ( $V_{IN} > V_{DD}$ ) .....           | 50 mA                   |
| Power Dissipation ( $T_A \leq 70^\circ C$ )         |                         |
| 5-Pin TO-220 .....                                  | 1.6W                    |
| CERDIP .....                                        | 800 mW                  |
| DFN .....                                           | <b>Note 2</b>           |
| PDIP .....                                          | 730 mW                  |
| SOIC .....                                          | 470 mW                  |
| Package Power Dissipation ( $T_A \leq 25^\circ C$ ) |                         |
| 5-Pin TO-220 (With Heatsink) .....                  | 12.5W                   |
| Thermal Impedances (To Case)                        |                         |
| 5-Pin TO-220 $R_{\theta J-C}$ .....                 | 10°C/W                  |

† Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

## DC CHARACTERISTICS

| Electrical Specifications: Unless otherwise noted, $T_A = +25^\circ C$ with $4.5V \leq V_{DD} \leq 18V$ . |           |                  |       |              |          |                                                    |
|-----------------------------------------------------------------------------------------------------------|-----------|------------------|-------|--------------|----------|----------------------------------------------------|
| Parameters                                                                                                | Sym       | Min              | Typ   | Max          | Units    | Conditions                                         |
| <b>Input</b>                                                                                              |           |                  |       |              |          |                                                    |
| Logic '1', High Input Voltage                                                                             | $V_{IH}$  | 2.4              | 1.8   | —            | V        |                                                    |
| Logic '0', Low Input Voltage                                                                              | $V_{IL}$  | —                | 1.3   | 0.8          | V        |                                                    |
| Input Voltage Range                                                                                       | $V_{IN}$  | -5               | —     | $V_{DD}+0.3$ | V        |                                                    |
| Input Current                                                                                             | $I_{IN}$  | -10              | —     | +10          | $\mu A$  | $0V \leq V_{IN} \leq V_{DD}$                       |
| <b>Output</b>                                                                                             |           |                  |       |              |          |                                                    |
| High Output Voltage                                                                                       | $V_{OH}$  | $V_{DD} - 0.025$ | —     | —            | V        | DC TEST                                            |
| Low Output Voltage                                                                                        | $V_{OL}$  | —                | —     | 0.025        | V        | DC TEST                                            |
| Output Resistance, High                                                                                   | $R_{OH}$  | —                | 2.1   | 2.8          | $\Omega$ | $I_{OUT} = 10 \text{ mA}, V_{DD} = 18V$            |
| Output Resistance, Low                                                                                    | $R_{OL}$  | —                | 1.5   | 2.5          | $\Omega$ | $I_{OUT} = 10 \text{ mA}, V_{DD} = 18V$            |
| Peak Output Current                                                                                       | $I_{PK}$  | —                | 6.0   | —            | A        | $V_{DD} = 18V$                                     |
| Latch-Up Protection Withstand Reverse Current                                                             | $I_{REV}$ | —                | > 1.5 | —            | A        | Duty cycle $\leq 2\%$ , $t \leq 300 \mu\text{sec}$ |
| <b>Switching Time (Note 1)</b>                                                                            |           |                  |       |              |          |                                                    |
| Rise Time                                                                                                 | $t_R$     | —                | 25    | 35           | ns       | Figure 4-1, $C_L = 2,500 \text{ pF}$               |
| Fall Time                                                                                                 | $t_F$     | —                | 25    | 35           | ns       | Figure 4-1, $C_L = 2,500 \text{ pF}$               |
| Delay Time                                                                                                | $t_{D1}$  | —                | 55    | 75           | ns       | Figure 4-1                                         |
| Delay Time                                                                                                | $t_{D2}$  | —                | 55    | 75           | ns       | Figure 4-1                                         |
| <b>Power Supply</b>                                                                                       |           |                  |       |              |          |                                                    |
| Power Supply Current                                                                                      | $I_S$     | —                | 0.45  | 1.5          | mA       | $V_{IN} = 3V$                                      |
|                                                                                                           |           | —                | 55    | 150          | $\mu A$  | $V_{IN} = 0V$                                      |
| Operating Input Voltage                                                                                   | $V_{DD}$  | 4.5              | —     | 18           | V        |                                                    |

**Note 1:** Switching times ensured by design.

**2:** Package power dissipation is dependent on the copper pad area on the PCB.

# TC4420/TC4429

## DC CHARACTERISTICS (OVER OPERATING TEMPERATURE RANGE)

| Electrical Specifications: Unless otherwise noted, over operating temperature range with $4.5V \leq V_{DD} \leq 18V$ . |          |                  |      |                |             |                                            |
|------------------------------------------------------------------------------------------------------------------------|----------|------------------|------|----------------|-------------|--------------------------------------------|
| Parameters                                                                                                             | Sym      | Min              | Typ  | Max            | Units       | Conditions                                 |
| <b>Input</b>                                                                                                           |          |                  |      |                |             |                                            |
| Logic '1', High Input Voltage                                                                                          | $V_{IH}$ | 2.4              | —    | —              | V           |                                            |
| Logic '0', Low Input Voltage                                                                                           | $V_{IL}$ | —                | —    | 0.8            | V           |                                            |
| Input Voltage Range                                                                                                    | $V_{IN}$ | -5               | —    | $V_{DD} + 0.3$ | V           |                                            |
| Input Current                                                                                                          | $I_{IN}$ | -10              | —    | +10            | $\mu A$     | $0V \leq V_{IN} \leq V_{DD}$               |
| <b>Output</b>                                                                                                          |          |                  |      |                |             |                                            |
| High Output Voltage                                                                                                    | $V_{OH}$ | $V_{DD} - 0.025$ | —    | —              | V           | DC TEST                                    |
| Low Output Voltage                                                                                                     | $V_{OL}$ | —                | —    | 0.025          | V           | DC TEST                                    |
| Output Resistance, High                                                                                                | $R_{OH}$ | —                | 3    | 5              | $\Omega$    | $I_{OUT} = 10 \text{ mA}$ , $V_{DD} = 18V$ |
| Output Resistance, Low                                                                                                 | $R_{OL}$ | —                | 2.3  | 5              | $\Omega$    | $I_{OUT} = 10 \text{ mA}$ , $V_{DD} = 18V$ |
| <b>Switching Time (Note 1)</b>                                                                                         |          |                  |      |                |             |                                            |
| Rise Time                                                                                                              | $t_R$    | —                | 32   | 60             | ns          | Figure 4-1, $C_L = 2,500 \text{ pF}$       |
| Fall Time                                                                                                              | $t_F$    | —                | 34   | 60             | ns          | Figure 4-1, $C_L = 2,500 \text{ pF}$       |
| Delay Time                                                                                                             | $t_{D1}$ | —                | 50   | 100            | ns          | Figure 4-1                                 |
| Delay Time                                                                                                             | $t_{D2}$ | —                | 65   | 100            | ns          | Figure 4-1                                 |
| <b>Power Supply</b>                                                                                                    |          |                  |      |                |             |                                            |
| Power Supply Current                                                                                                   | $I_S$    | —                | 0.45 | 3              | $\text{mA}$ | $V_{IN} = 3V$                              |
|                                                                                                                        |          | —                | 60   | 400            | $\mu A$     | $V_{IN} = 0V$                              |
| Operating Input Voltage                                                                                                | $V_{DD}$ | 4.5              | —    | 18             | V           |                                            |

**Note 1:** Switching times ensured by design.

## TEMPERATURE CHARACTERISTICS

| Electrical Specifications: Unless otherwise noted, all parameters apply with $4.5V \leq V_{DD} \leq 18V$ . |               |     |      |      |               |                                                     |
|------------------------------------------------------------------------------------------------------------|---------------|-----|------|------|---------------|-----------------------------------------------------|
| Parameters                                                                                                 | Sym           | Min | Typ  | Max  | Units         | Conditions                                          |
| <b>Temperature Ranges</b>                                                                                  |               |     |      |      |               |                                                     |
| Specified Temperature Range (C)                                                                            | $T_A$         | 0   | —    | +70  | $^{\circ}C$   |                                                     |
| Specified Temperature Range (I)                                                                            | $T_A$         | -25 | —    | +85  | $^{\circ}C$   |                                                     |
| Specified Temperature Range (E)                                                                            | $T_A$         | -40 | —    | +85  | $^{\circ}C$   |                                                     |
| Specified Temperature Range (V)                                                                            | $T_A$         | -40 | —    | +125 | $^{\circ}C$   |                                                     |
| Maximum Junction Temperature                                                                               | $T_J$         | —   | —    | +150 | $^{\circ}C$   |                                                     |
| Storage Temperature Range                                                                                  | $T_A$         | -65 | —    | +150 | $^{\circ}C$   |                                                     |
| <b>Package Thermal Resistances</b>                                                                         |               |     |      |      |               |                                                     |
| Thermal Resistance, 5L-TO-220                                                                              | $\theta_{JA}$ | —   | 71   | —    | $^{\circ}C/W$ |                                                     |
| Thermal Resistance, 8L-CERDIP                                                                              | $\theta_{JA}$ | —   | 150  | —    | $^{\circ}C/W$ |                                                     |
| Thermal Resistance, 8L-6x5 DFN                                                                             | $\theta_{JA}$ | —   | 33.2 | —    | $^{\circ}C/W$ | Typical four-layer board with vias to ground plane. |
| Thermal Resistance, 8L-PDIP                                                                                | $\theta_{JA}$ | —   | 125  | —    | $^{\circ}C/W$ |                                                     |
| Thermal Resistance, 8L-SOIC                                                                                | $\theta_{JA}$ | —   | 155  | —    | $^{\circ}C/W$ |                                                     |

## 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$  with  $4.5\text{V} \leq V_{DD} \leq 18\text{V}$ .



**FIGURE 2-1:** Rise Time vs. Supply Voltage.



**FIGURE 2-4:** Fall Time vs. Supply Voltage.



**FIGURE 2-2:** Rise Time vs. Capacitive Load.



**FIGURE 2-5:** Fall Time vs. Capacitive Load.



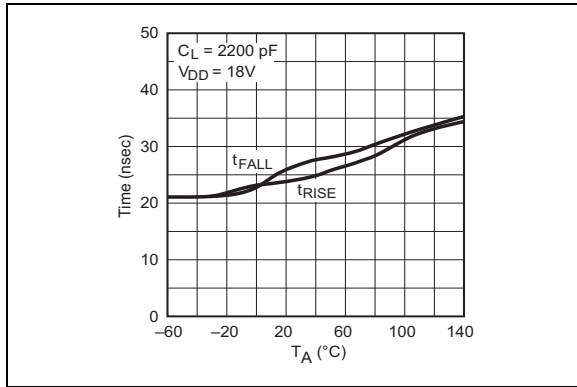
**FIGURE 2-3:** Propagation Delay Time vs. Temperature.



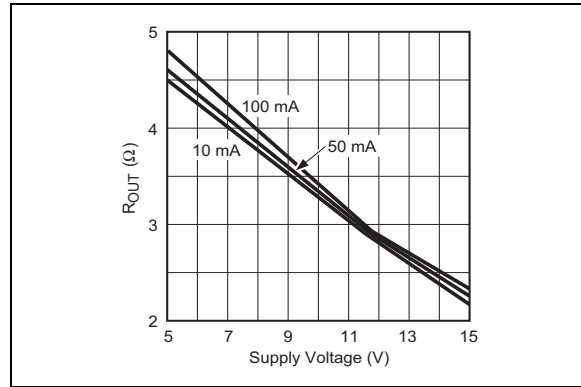
**FIGURE 2-6:** Supply Current vs. Capacitive Load.

# TC4420/TC4429

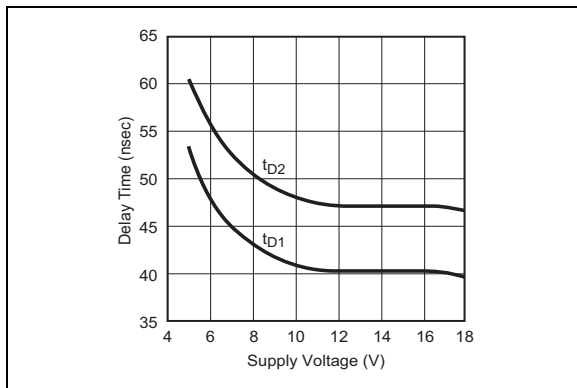
**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$  with  $4.5\text{V} \leq V_{DD} \leq 18\text{V}$ .



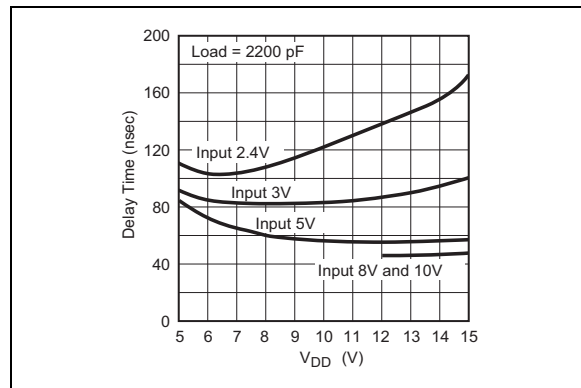
**FIGURE 2-7:** Rise and Fall Times vs. Temperature.



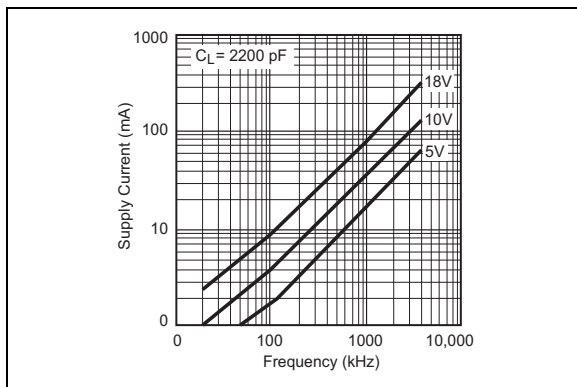
**FIGURE 2-10:** High-State Output Resistance vs. Supply Voltage.



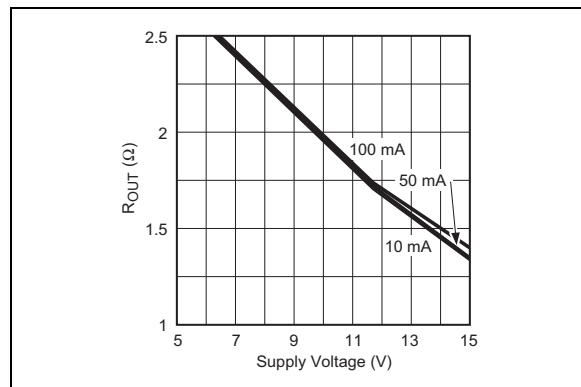
**FIGURE 2-8:** Propagation Delay Time vs. Supply Voltage.



**FIGURE 2-11:** Effect of Input Amplitude on Propagation Delay.

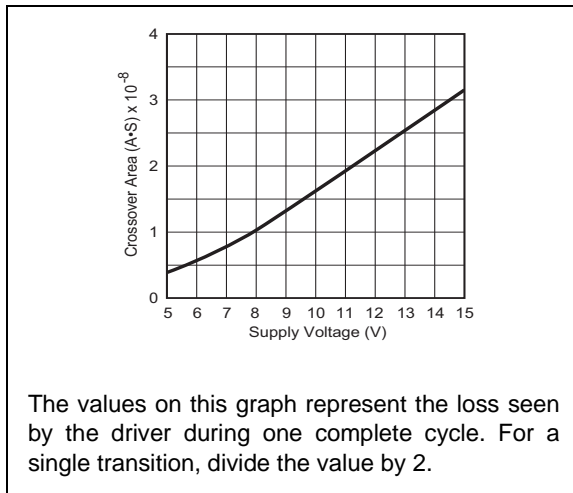


**FIGURE 2-9:** Supply Current vs. Frequency.



**FIGURE 2-12:** Low-State Output Resistance vs. Supply Voltage.

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$  with  $4.5\text{V} \leq V_{DD} \leq 18\text{V}$ .



**FIGURE 2-13:** Crossover Energy.

# TC4420/TC4429

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

**TABLE 3-1: PIN FUNCTION TABLE**

| Pin No.<br>8-Pin CERDIP/<br>PDIP/SOIC | Pin No.<br>8-Pin DFN | Pin No.<br>5-Pin TO-220 | Symbol          | Description                                   |
|---------------------------------------|----------------------|-------------------------|-----------------|-----------------------------------------------|
| 1                                     | 1                    | —                       | V <sub>DD</sub> | Supply input, 4.5V to 18V                     |
| 2                                     | 2                    | 1                       | INPUT           | Control input, TTL/CMOS compatible input      |
| 3                                     | 3                    | —                       | NC              | No Connection                                 |
| 4                                     | 4                    | 2                       | GND             | Ground                                        |
| 5                                     | 5                    | 4                       | GND             | Ground                                        |
| 6                                     | 6                    | 5                       | OUTPUT          | CMOS push-pull output                         |
| 7                                     | 7                    | —                       | OUTPUT          | CMOS push-pull output                         |
| 8                                     | 8                    | 3                       | V <sub>DD</sub> | Supply input, 4.5V to 18V                     |
| —                                     | PAD                  | —                       | NC              | Exposed Metal Pad                             |
| —                                     | —                    | TAB                     | V <sub>DD</sub> | Metal Tab is at the V <sub>DD</sub> Potential |

### 3.1 Supply Input (V<sub>DD</sub>)

The V<sub>DD</sub> input is the bias supply for the MOSFET driver and is rated for 4.5V to 18V with respect to the ground pins. The V<sub>DD</sub> input should be bypassed to ground with a local ceramic capacitor. The value of the capacitor should be chosen based on the capacitive load that is being driven. A minimum value of 1.0  $\mu$ F is suggested.

### 3.2 Control Input

The MOSFET driver input is a high-impedance, TTL/CMOS compatible input. The input circuitry of the TC4420/TC4429 MOSFET driver also has a “speed-up” capacitor. This helps to decrease the propagation delay times of the driver. Because of this, input signals with slow rising or falling edges should not be used, as this can result in double-pulsing of the MOSFET driver output.

### 3.3 CMOS Push-Pull Output

The MOSFET driver output is a low-impedance, CMOS, push-pull style output capable of driving a capacitive load with 6.0A peak currents. The MOSFET driver output is capable of withstanding 1.5A peak reverse currents of either polarity.

### 3.4 Ground

The ground pins are the return path for the bias current and the high peak currents that discharge the load capacitor. The ground pins should be tied into a ground plane or have very short traces to the bias supply source return.

### 3.5 Exposed Metal Pad

The exposed metal pad of the 6x5 DFN package is not internally connected to any potential. Therefore, this pad can be connected to a ground plane or other copper plane on a printed circuit board (PCB) to aid in heat removal from the package.



## 4.0 APPLICATIONS INFORMATION



**FIGURE 4-1:** Switching Time Test Circuits.

# TC4420/TC4429

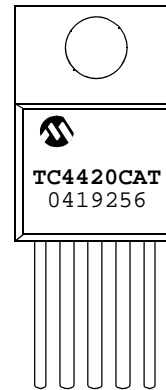
## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

5-Lead TO-220



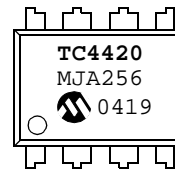
Example:



8-Lead CERP (300 mil)



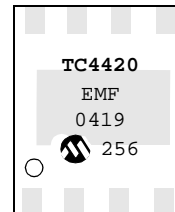
Example:



8-Lead DFN



Example:

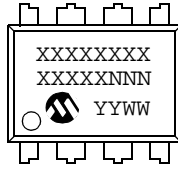


|                |        |                                                                                                                  |
|----------------|--------|------------------------------------------------------------------------------------------------------------------|
| <b>Legend:</b> | XX...X | Customer-specific information                                                                                    |
|                | Y      | Year code (last digit of calendar year)                                                                          |
|                | YY     | Year code (last 2 digits of calendar year)                                                                       |
|                | WW     | Week code (week of January 1 is week '01')                                                                       |
|                | NNN    | Alphanumeric traceability code                                                                                   |
|                | (e3)   | Pb-free JEDEC designator for Matte Tin (Sn)                                                                      |
|                | *      | This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. |

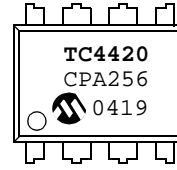
**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

## Package Marking Information (Continued)

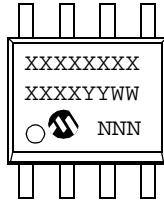
8-Lead PDIP (300 mil)



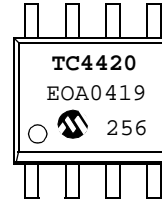
Example:



8-Lead SOIC (150 mil)



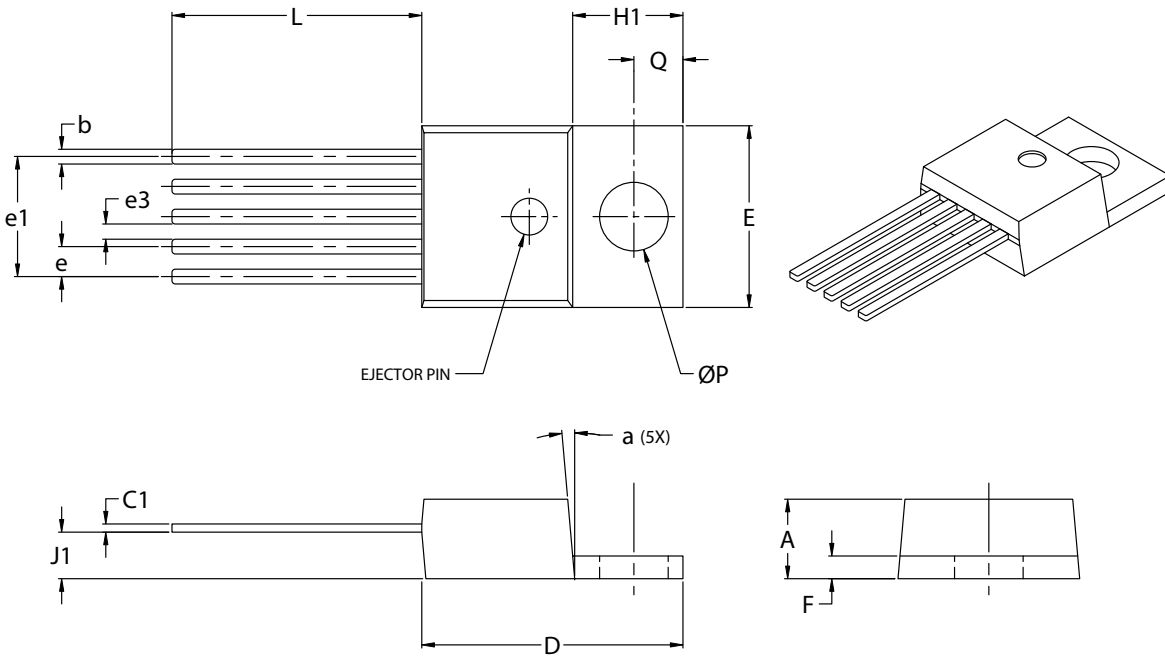
Example:



# TC4420/TC4429

## 5-Lead Plastic Transistor Outline (AT) (TO-220)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits       | Units | INCHES* |      | MILLIMETERS |       |
|------------------------|-------|---------|------|-------------|-------|
|                        |       | MIN     | MAX  | MIN         | MAX   |
| Lead Pitch             | e     | .060    | .072 | 1.52        | 1.83  |
| Overall Lead Centers   | e1    | .263    | .273 | 6.68        | 6.93  |
| Space Between Leads    | e3    | .030    | .040 | 0.76        | 1.02  |
| Overall Height         | A     | .160    | .190 | 4.06        | 4.83  |
| Overall Width          | E     | .385    | .415 | 9.78        | 10.54 |
| Overall Length         | D     | .560    | .590 | 14.22       | 14.99 |
| Flag Length            | H1    | .234    | .258 | 5.94        | 6.55  |
| Flag Thickness         | F     | .045    | .055 | 1.14        | 1.40  |
| Through Hole Center    | Q     | .103    | .113 | 2.62        | 2.87  |
| Through Hole Diameter  | P     | .146    | .156 | 3.71        | 3.96  |
| Lead Length            | L     | .540    | .560 | 13.72       | 14.22 |
| Base to Bottom of Lead | J1    | .090    | .115 | 2.29        | 2.92  |
| Lead Thickness         | C1    | .014    | .022 | 0.36        | 0.56  |
| Lead Width             | b     | .025    | .040 | 0.64        | 1.02  |
| Mold Draft Angle       | a     | 3°      | 7°   | 3°          | 7°    |

\*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC equivalent: TO-220

Drawing No. C04-036

## 8-Lead Ceramic Dual In-line – 300 mil (JA) (CERDIP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                      |        | INCHES* |      |      | MILLIMETERS |      |       |
|----------------------------|--------|---------|------|------|-------------|------|-------|
| Dimension                  | Limits | MIN     | NOM  | MAX  | MIN         | NOM  | MAX   |
| Number of Pins             | n      |         | 8    |      |             | 8    |       |
| Pitch                      | p      |         | .100 |      |             | 2.54 |       |
| Top to Seating Plane       | A      | .160    | .180 | .200 | 4.06        | 4.57 | 5.08  |
| Standoff §                 | A1     | .020    | .030 | .040 | 0.51        | 0.77 | 1.02  |
| Shoulder to Shoulder Width | E      | .290    | .305 | .320 | 7.37        | 7.75 | 8.13  |
| Ceramic Pkg. Width         | E1     | .230    | .265 | .300 | 5.84        | 6.73 | 7.62  |
| Overall Length             | D      | .370    | .385 | .400 | 9.40        | 9.78 | 10.16 |
| Tip to Seating Plane       | L      | .125    | .163 | .200 | 3.18        | 4.13 | 5.08  |
| Lead Thickness             | c      | .008    | .012 | .015 | 0.20        | 0.29 | 0.38  |
| Upper Lead Width           | B1     | .045    | .055 | .065 | 1.14        | 1.40 | 1.65  |
| Lower Lead Width           | B      | .016    | .018 | .020 | 0.41        | 0.46 | 0.51  |
| Overall Row Spacing        | eB     | .320    | .360 | .400 | 8.13        | 9.15 | 10.16 |

\*Controlling Parameter

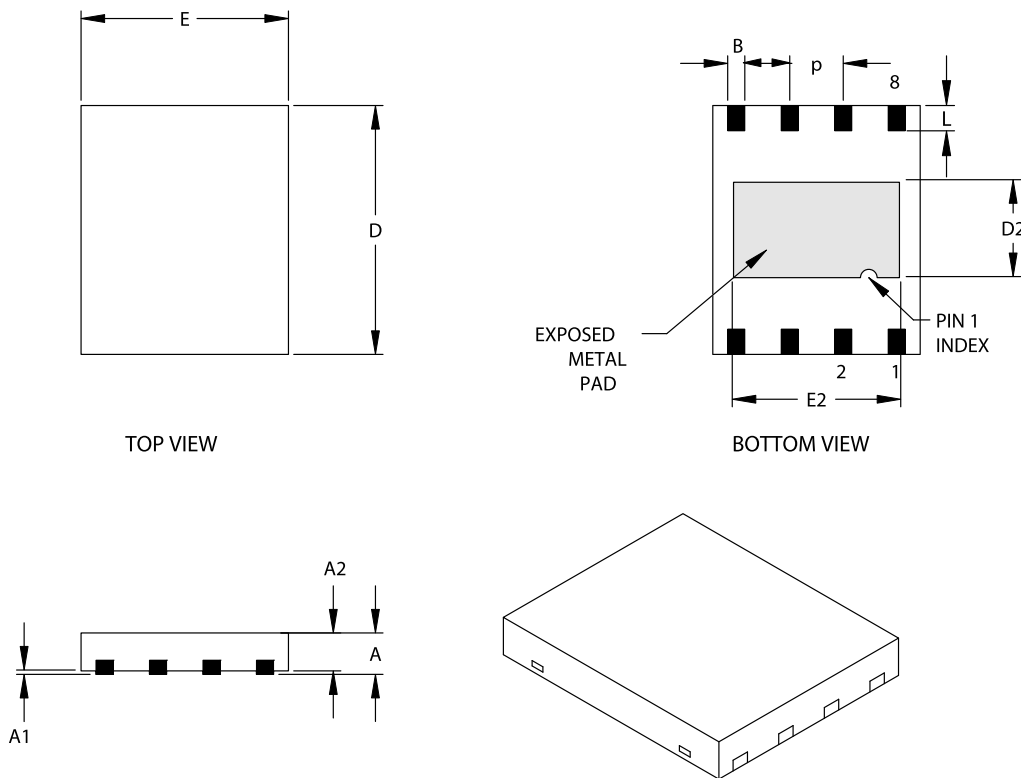
JEDEC Equivalent: MS-030

Drawing No. C04-010

# TC4420/TC4429

## 8-Lead Plastic Dual Flat No Lead Package (MF) 6x5 mm Body (DFN-S) – Saw Singulated

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units              |    | INCHES   |       |      | MILLIMETERS* |      |      |
|--------------------|----|----------|-------|------|--------------|------|------|
| Dimension Limits   |    | MIN      | NOM   | MAX  | MIN          | NOM  | MAX  |
| Number of Pins     | n  | 8        |       |      | 8            |      |      |
| Pitch              | p  | .050 BSC |       |      | 1.27 BSC     |      |      |
| Overall Height     | A  | .033     | .035  | .037 | 0.85         | 0.90 | 0.95 |
| Package Thickness  | A2 | .031     | .035  | .037 | 0.80         | 0.89 | 0.95 |
| Standoff           | A1 | .000     | .0004 | .002 | 0.00         | 0.01 | 0.05 |
| Base Thickness     | A3 | .007     | .008  | .009 | 0.17         | 0.20 | 0.23 |
| Overall Length     | E  | .195     | .197  | .199 | 4.95         | 5.00 | 5.05 |
| Exposed Pad Length | E2 | .152     | .157  | .163 | 3.85         | 4.00 | 4.15 |
| Overall Width      | D  | .234     | .236  | .238 | 5.95         | 6.00 | 6.05 |
| Exposed Pad Width  | D2 | .089     | .091  | .093 | 2.25         | 2.30 | 2.35 |
| Lead Width         | B  | .014     | .016  | .019 | 0.35         | 0.40 | 0.47 |
| Lead Length        | L  | .024     |       | .026 | 0.60         |      | 0.65 |

Notes:

JEDEC equivalent: MO-220

Drawing No. C04-122

Revised 11/3/03

## 8-Lead Plastic Dual In-line (PA) – 300 mil (PDIP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                      |        | INCHES* |      |      | MILLIMETERS |      |       |
|----------------------------|--------|---------|------|------|-------------|------|-------|
| Dimension                  | Limits | MIN     | NOM  | MAX  | MIN         | NOM  | MAX   |
| Number of Pins             | n      |         | 8    |      |             | 8    |       |
| Pitch                      | p      |         | .100 |      |             | 2.54 |       |
| Top to Seating Plane       | A      | .140    | .155 | .170 | 3.56        | 3.94 | 4.32  |
| Molded Package Thickness   | A2     | .115    | .130 | .145 | 2.92        | 3.30 | 3.68  |
| Base to Seating Plane      | A1     | .015    |      |      | 0.38        |      |       |
| Shoulder to Shoulder Width | E      | .300    | .313 | .325 | 7.62        | 7.94 | 8.26  |
| Molded Package Width       | E1     | .240    | .250 | .260 | 6.10        | 6.35 | 6.60  |
| Overall Length             | D      | .360    | .373 | .385 | 9.14        | 9.46 | 9.78  |
| Tip to Seating Plane       | L      | .125    | .130 | .135 | 3.18        | 3.30 | 3.43  |
| Lead Thickness             | c      | .008    | .012 | .015 | 0.20        | 0.29 | 0.38  |
| Upper Lead Width           | B1     | .045    | .058 | .070 | 1.14        | 1.46 | 1.78  |
| Lower Lead Width           | B      | .014    | .018 | .022 | 0.36        | 0.46 | 0.56  |
| Overall Row Spacing        | § eB   | .310    | .370 | .430 | 7.87        | 9.40 | 10.92 |
| Mold Draft Angle Top       | α      | 5       | 10   | 15   | 5           | 10   | 15    |
| Mold Draft Angle Bottom    | β      | 5       | 10   | 15   | 5           | 10   | 15    |

\* Controlling Parameter  
 § Significant Characteristic

Notes:  
 Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.  
 JEDEC Equivalent: MS-001  
 Drawing No. C04-018

# TC4420/TC4429

## 8-Lead Plastic Small Outline (OA) – Narrow, 150 mil (SOIC)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits         | Units    | INCHES* |      |      | MILLIMETERS |      |      |
|--------------------------|----------|---------|------|------|-------------|------|------|
|                          | n        | MIN     | NOM  | MAX  | MIN         | NOM  | MAX  |
| Number of Pins           | n        |         | 8    |      |             | 8    |      |
| Pitch                    | p        |         | .050 |      |             | 1.27 |      |
| Overall Height           | A        | .053    | .061 | .069 | 1.35        | 1.55 | 1.75 |
| Molded Package Thickness | A2       | .052    | .056 | .061 | 1.32        | 1.42 | 1.55 |
| Standoff §               | A1       | .004    | .007 | .010 | 0.10        | 0.18 | 0.25 |
| Overall Width            | E        | .228    | .237 | .244 | 5.79        | 6.02 | 6.20 |
| Molded Package Width     | E1       | .146    | .154 | .157 | 3.71        | 3.91 | 3.99 |
| Overall Length           | D        | .189    | .193 | .197 | 4.80        | 4.90 | 5.00 |
| Chamfer Distance         | h        | .010    | .015 | .020 | 0.25        | 0.38 | 0.51 |
| Foot Length              | L        | .019    | .025 | .030 | 0.48        | 0.62 | 0.76 |
| Foot Angle               | $\phi$   | 0       | 4    | 8    | 0           | 4    | 8    |
| Lead Thickness           | c        | .008    | .009 | .010 | 0.20        | 0.23 | 0.25 |
| Lead Width               | B        | .013    | .017 | .020 | 0.33        | 0.42 | 0.51 |
| Mold Draft Angle Top     | $\alpha$ | 0       | 12   | 15   | 0           | 12   | 15   |
| Mold Draft Angle Bottom  | $\beta$  | 0       | 12   | 15   | 0           | 12   | 15   |

\* Controlling Parameter

§ Significant Characteristic

**Notes:**

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-012

Drawing No. C04-057



## 6.0 REVISION HISTORY

### Revision D (December 2012)

Added a note to each package outline drawing.

# TC4420/TC4429

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| <u>PART NO.</u>    | <u>X</u>          | <u>XX</u>                                                                                  | <u>XXX</u>    | <u>X</u> | <b>Examples:</b> |                                                                           |
|--------------------|-------------------|--------------------------------------------------------------------------------------------|---------------|----------|------------------|---------------------------------------------------------------------------|
| Device             | Temperature Range | Package                                                                                    | Tape and Reel | PB Free  |                  |                                                                           |
| Device:            | TC4420:           | 6A High-Speed MOSFET Driver, Non-Inverting                                                 |               |          | a) TC4420CAT:    | 6A High-Speed MOSFET Driver, Non-inverting, TO-220 package, 0°C to +70°C. |
|                    | TC4429:           | 6A High-Speed MOSFET Driver, Inverting                                                     |               |          | b) TC4420EOA:    | 6A High-Speed MOSFET Driver, Non-inverting, SOIC package, -40°C to +85°C. |
| Temperature Range: | C =               | 0°C to +70°C (PDIP, SOIC, and TO-220 Only)                                                 |               |          | c) TC4420VMF:    | 6A High-Speed MOSFET Driver, Non-inverting, DFN package, -40°C to +125°C. |
|                    | I =               | -25°C to +85°C (CERDIP Only)                                                               |               |          | a) TC4429CAT:    | 6A High-Speed MOSFET Driver, Inverting, TO-220 package, 0°C to +70°C      |
|                    | E =               | -40°C to +85°C                                                                             |               |          | b) TC4429EPA:    | 6A High-Speed MOSFET Driver, Inverting, PDIP package, -40°C to +85°C      |
|                    | V =               | -40°C to +125°C                                                                            |               |          | c) TC4429VMF:    | 6A High-Speed MOSFET Driver, Inverting, DFN package, -40°C to +125°C      |
| Package:           | AT =              | TO-220, 5-lead (C-Temp Only)                                                               |               |          |                  |                                                                           |
|                    | JA =              | Ceramic Dual In-line (300 mil Body), 8-lead (I-Temp Only)                                  |               |          |                  |                                                                           |
|                    | MF =              | Dual, Flat, No-Lead (6X5 mm Body), 8-lead                                                  |               |          |                  |                                                                           |
|                    | MF713 =           | Dual, Flat, No-Lead (6X5 mm Body), 8-lead (Tape and Reel)                                  |               |          |                  |                                                                           |
|                    | PA =              | Plastic DIP (300 mil Body), 8-lead                                                         |               |          |                  |                                                                           |
|                    | OA =              | Plastic SOIC, (150 mil Body), 8-lead                                                       |               |          |                  |                                                                           |
|                    | OA713 =           | Plastic SOIC, (150 mil Body), 8-lead (Tape and Reel)                                       |               |          |                  |                                                                           |
| PB Free            | G =               | Lead-Free device*                                                                          |               |          |                  |                                                                           |
|                    |                   | = Blank                                                                                    |               |          |                  |                                                                           |
|                    |                   | * Available on selected packages. Contact your local sales representative for availability |               |          |                  |                                                                           |

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# TC4420/TC4429

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NOTES:

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ISBN: 9781620767948

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Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А